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**NTE5552-I, NTE5554-I,
NTE5556-I, NTE5558-I**
Silicon Controlled Rectifier (SCR)
25 Amp, TO220AB
Isolated Tab

Description:

The NTE5552-I thru NTE5558-I are 25 Amp SCR's designed primarily for half-wave AC control applications, such as motor controls, overvoltage crowbar protection, capacitive discharge ignition, voltage regulation, and welding equipment.

Features:

- Suitable for General Purpose AC Switching
- I_{GT} 40mA Max.
- Isolated Tab

Absolute Maximum Ratings: ($T_A = +25^\circ\text{C}$ unless otherwise specified)

Repetitive Peak Off-State Voltage, V_{DRM}

NTE5552-I	200V
NTE5554-I	400V
NTE5556-I	600V
NTE5558-I	800V

Peak Reverse Blocking Voltage, V_{RRM}

NTE5552-I	200V
NTE5554-I	400V
NTE5556-I	600V
NTE5558-I	800V

Maximum Peak Reverse Gate Voltage, V_{RGM}

RMS On-State Current (Full Sine Wave, $T_C = +75^\circ\text{C}$), $I_T(\text{RMS})$

Average On-State Current ($T_C = +75^\circ\text{C}$), $I_T(\text{AV})$

Non-Repetitive Surge Peak On-State Current (Full Cycle, T_J Initial = $+25^\circ\text{C}$), I_{TSM}

F = 50Hz	320A
F = 60Hz	350A

I^2t Value for Fusing ($t_p = 10\text{ms}$), I^2t

Critical Rate of Rise of On-State Current ($I_G = 2 \times I_{GT}$, $t_r < 100\text{ns}$, $T_J = +125^\circ\text{C}$), di/dt

NTE5552-I, NTE5554-I, NTE5556-I	100A/ μs
NTE5558-I	50A/ μs

Forward Peak Gate Current ($t_p = 20\mu\text{s}$, $T_J = +125^\circ\text{C}$), I_{GM}

NTE5552-I, NTE5554-I, NTE5556-I	2A
NTE5558-I	4A

Average Gate Power Dissipation ($T_J = +125^\circ\text{C}$), $P_{G(AV)}$

Isolation Voltage, V_{ISO}

Absolute Maximum Ratings (Cont'd): ($T_A = +25^\circ\text{C}$ unless otherwise specified)

Operating Junction Temperature Range, T_J	-40° to +125°C
Storage Temperature Range, T_{stg}	-40° to +150°C
Thermal Resistance, Junction-to-Case, R_{thJC}	1.9°C/W
Thermal Resistance, Junction-to-Ambient, R_{thJA}	60°C/W

Electrical Characteristics: ($T_C = +25^\circ\text{C}$ unless otherwise noted.)

Parameter	Symbol	Min	Typ	Max	Unit
Gate Trigger Current ($V_D = 12\text{V}$, $R_L = 30\Omega$)	I_{GT}	-	-	40	mA
Gate Trigger Voltage ($V_D = 12\text{V}$, $R_L = 30\Omega$)	V_{GT}	-	-	1.3	V
Gate Non-Trigger Voltage ($V_D = \text{Rated } V_{\text{DRM}}$, $R_L = 3.3\text{k}\Omega$, $T_J = +125^\circ\text{C}$)	V_{GD}	0.2	-	-	V
Holding Current ($I_T = 500\text{mA}$, Gate Open)	I_H	-	-	50	mA
Latching Current ($I_G = 1.2 I_{\text{GT}}$)	I_L	-	-	90	mA
Critical Rate of Rise of Off-State Voltage ($V_D = 67\% V_{\text{DRM}}$, Gate Open, $T_J = +125^\circ\text{C}$)	dv/dt	1000	-	-	V/ μs
Forward "ON" Voltage NTE5558-I ($I_{\text{TM}} = 32\text{A}$, $t_p = 380\mu\text{s}$, $T_J = +25^\circ\text{C}$) All Other Devices ($I_{\text{TM}} = 50\text{A}$, $t_p = 380\mu\text{s}$, $T_J = +25^\circ\text{C}$)	V_{TM}	-	-	1.6	V
Peak Forward or Reverse Blocking Current, (Rated V_{DRM} or V_{RRM})	$I_{\text{DRM}}, I_{\text{RRM}}$	-	-	5	μA
		-	-	4	mA

